

NextPower 100 V, 4.3 mOhm, 120 A, N-channel MOSFET in LFPAK56E package 11 June 2021

Product data sheet

1. General description

NextPower 100 V, standard level gate drive MOSFET. Qualified to 175 °C and recommended for industrial and consumer applications.

2. Features and benefits

- Low Q_{rr} for higher efficiency and lower spiking
- 120 A I_D (max) demonstrated continuous current rating ٠
- Low Q_G × R_{DSon} FOM for high efficiency switching applications
- Strong avalanche energy rating (E_{as})
- Avalanche rated and 100% tested
- Ha-free and RoHS compliant LFPAK56E package

3. Applications

- Synchronous rectifier in AC-DC and DC-DC
- Primary side switch 48 V DC-DC •
- BLDC motor control
- USB-PD adapters
- Full-bridge and half-bridge applications •
- Flyback and resonant topologies

4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	100	V
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	120	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	294	W
Tj	junction temperature			-55	-	175	°C
Static chara	cteristics			_	_		
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 12		-	3.3	4.3	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; Fig. 13		-	5.1	6.9	mΩ
Dynamic cha	aracteristics						
Q _{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V;		5	18	41	nC
Q _{G(tot)}	total gate charge	<u>Fig. 14; Fig. 15</u>		40	80	120	nC
Avalanche r	uggedness	1		I			
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I_D = 52.6 A; $V_{sup} \le 100$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped; t_p = 95 μs; Fig. 4	[1]	-	-	325	mJ

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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
Source-drain d	Source-drain diode							
Qr	recovered charge	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 50 \text{ V}; \text{ Fig. 18}$		-	44	-	nC	

[1] Protected by 100% test

5. Pinning information

Table 2	. Pinning info	rmation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	recel	
2	S	source		
3	S	source		D
4	G	gate		
mb	D	mounting base; connected to drain	LFPAK56E; Power- SO8 (SOT1023)	G HEAD MEDDOTE

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN3R9-100YSF	,	plastic, single-ended surface-mounted package (LFPAK56); 4 leads; 1.27 mm pitch	SOT1023			

7. Marking

Table 4. Marking codes						
Type number	Marking code					
PSMN3R9-100YSF	3F9S10J					

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	100	V
V _{DGR}	drain-gate voltage	25 °C ≤ T_j ≤ 175 °C; R_{GS} = 20 kΩ	-	100	V
V _{GS}	gate-source voltage		-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	294	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	120	А
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>	-	120	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3	-	690	А
T _{stg}	storage temperature		-55	175	°C

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Symbol	Parameter	Conditions		Min	Max	Unit
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drain	diode					
I _S	source current	T _{mb} = 25 °C		-	120	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	690	А
Avalanche ru	ggedness		ŀ			
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 52.6 \text{ A}; \text{V}_{sup} \leq \ 100 \text{V}; \text{R}_{GS} = 50 \Omega; \\ &\text{V}_{GS} = 10 \text{V}; \text{T}_{j(\text{init})} = 25 ^{\circ}\text{C}; \text{ unclamped}; \\ &t_{p} = 95 \mu\text{s}; \frac{\text{Fig. 4}}{2} \end{split} $	[1]	-	325	mJ
I _{AS}	non-repetitive avalanche current	V_{sup} = 100 V; V _{GS} = 10 V; T _{j(init)} = 25 °C; R _{GS} = 50 Ω; <u>Fig. 4</u>	[1]	-	52.6	A

[1] Protected by 100% test

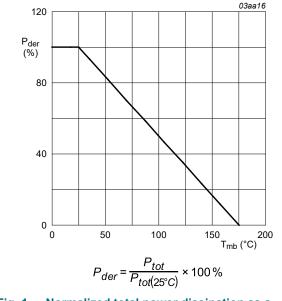
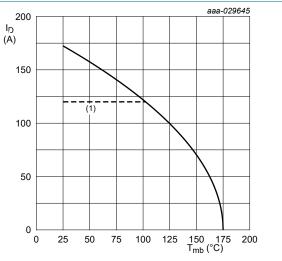


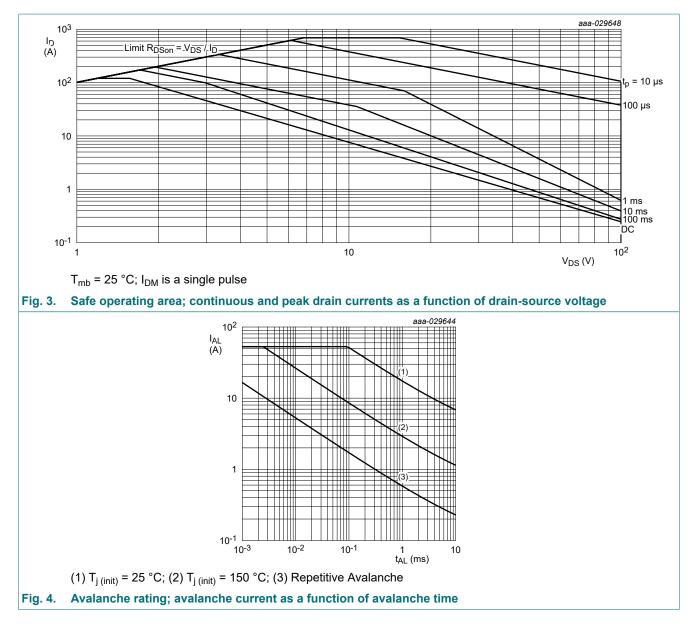
Fig. 1. Normalized total power dissipation as a function of mounting base temperature



 $V_{GS} \ge 10 V$

(1) 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

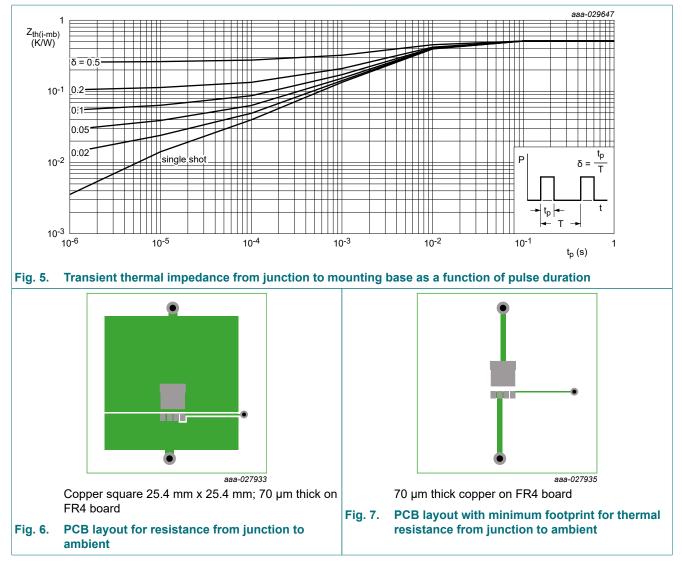
Fig. 2. Continuous drain current as a function of mounting base temperature



9. Thermal characteristics

Table 6. Thermal characteristics

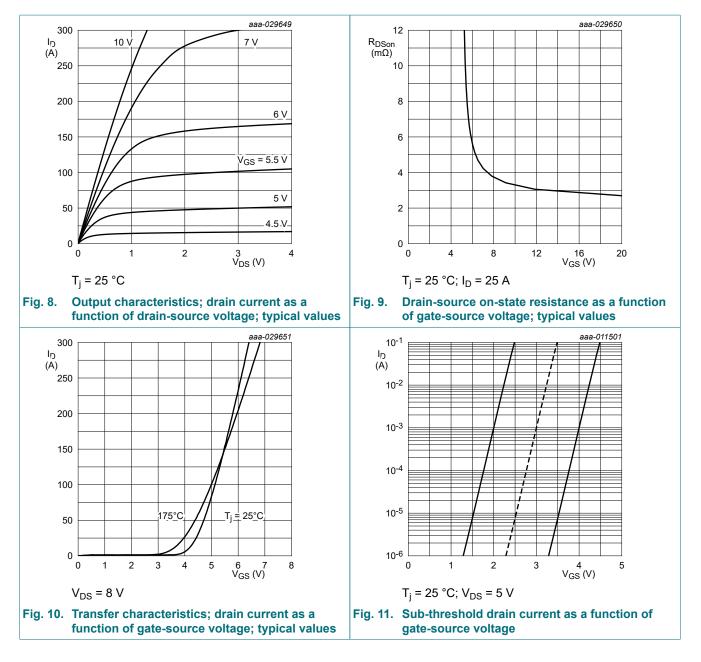
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>5</u>	-	0.45	0.51	K/W
	thermal resistance from	Fig. 6	-	42	-	K/W
	junction to ambient	Fig. 7	-	85	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	100	-	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	90	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 11$	2	3	4	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C	-	1.65	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C	-	3.5	-	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-8.4	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	0.03	1	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	10	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA

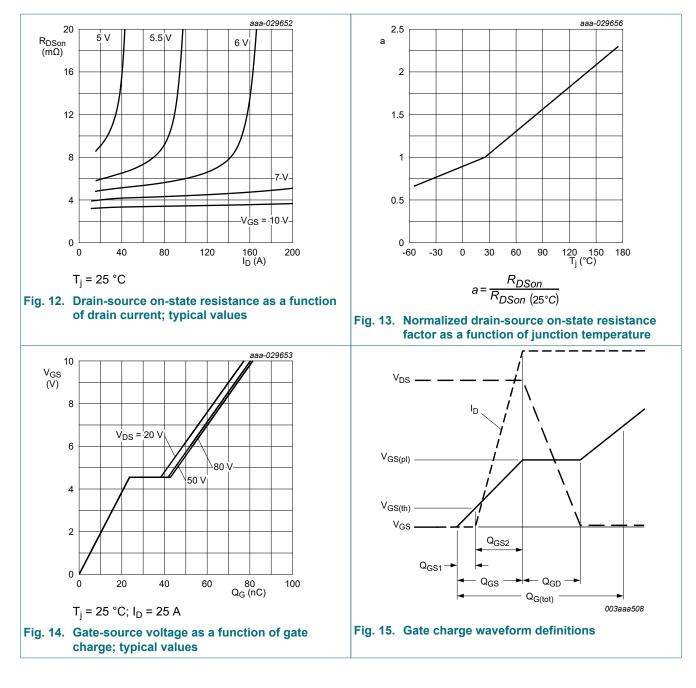
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 12	-	3.3	4.3	mΩ
		V _{GS} = 7 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 12</u>	-	3.9	6.1	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; <u>Fig. 13</u>	-	5.1	6.9	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 13	-	7.3	9.9	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.4	0.83	1.7	Ω
Dynamic ch	aracteristics					
Q _{G(tot)}	total gate charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; Fig. 14; Fig. 15	40	80	120	nC
		I _D = 0 A; V _{DS} = 0 V; V _{GS} = 10 V	-	42	-	nC
Q _{GS}	gate-source charge	I _D = 25 A; V _{DS} = 50 V; V _{GS} = 10 V; Fig. 14; Fig. 15	14	23.6	33	nC
Q _{GS(th)}	pre-threshold gate- source charge		-	15.3	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	8.3	-	nC
Q _{GD}	gate-drain charge		5	18	41	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 25 A; V _{DS} = 50 V; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	4.5	-	V
C _{iss}	input capacitance	V _{DS} = 50 V; V _{GS} = 0 V; f = 1 MHz;	3300	5520	7730	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>	800	1335	2140	pF
C _{rss}	reverse transfer capacitance		3	29	75	pF
t _{d(on)}	turn-on delay time	V_{DS} = 50 V; R _L = 2 Ω; V _{GS} = 10 V;	-	22	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$	-	18	-	ns
t _{d(off)}	turn-off delay time] [-	46	-	ns
t _f	fall time] [-	26	-	ns
Source-drai	in diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 17</u>	-	0.82	1	V
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{V}_{GS} = 0 \text{ V};$	-	43	-	ns
Q _r	recovered charge	V _{DS} = 50 V; <u>Fig. 18</u>	-	44	-	nC

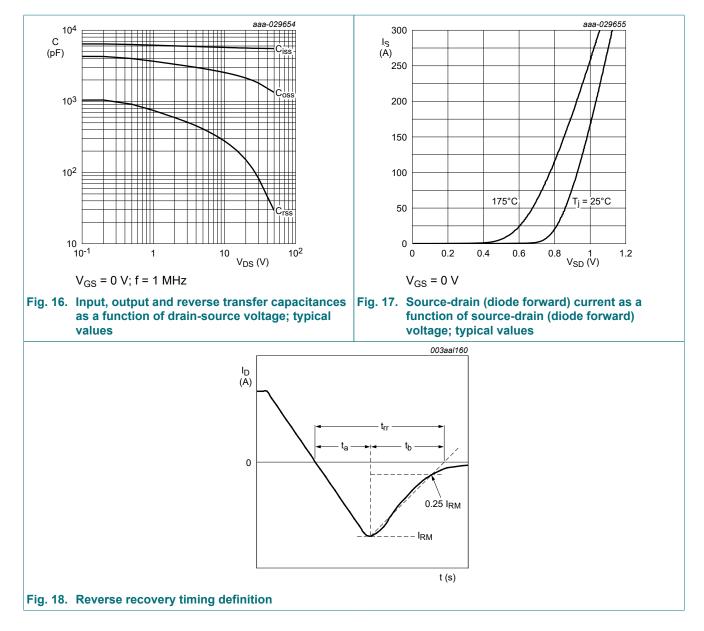


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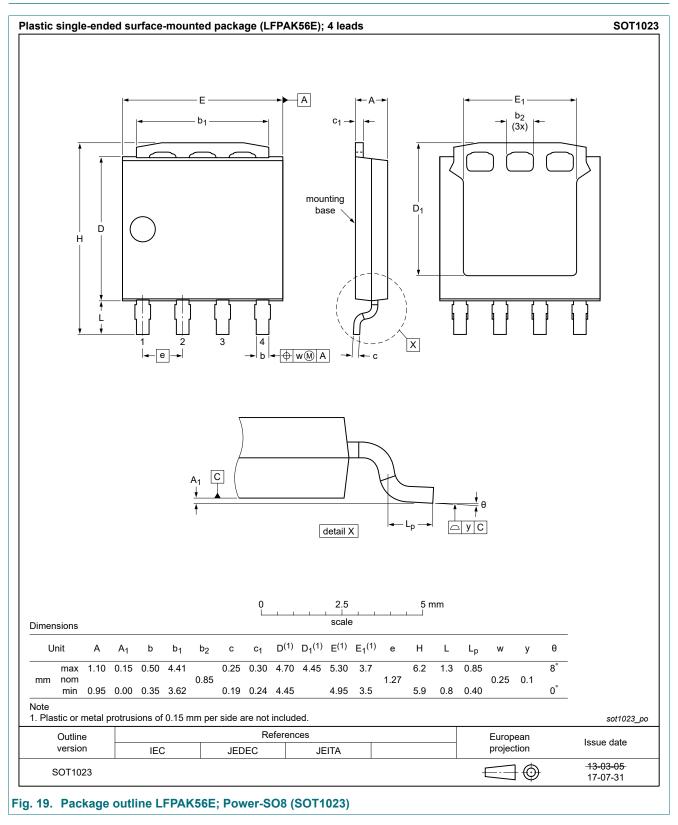
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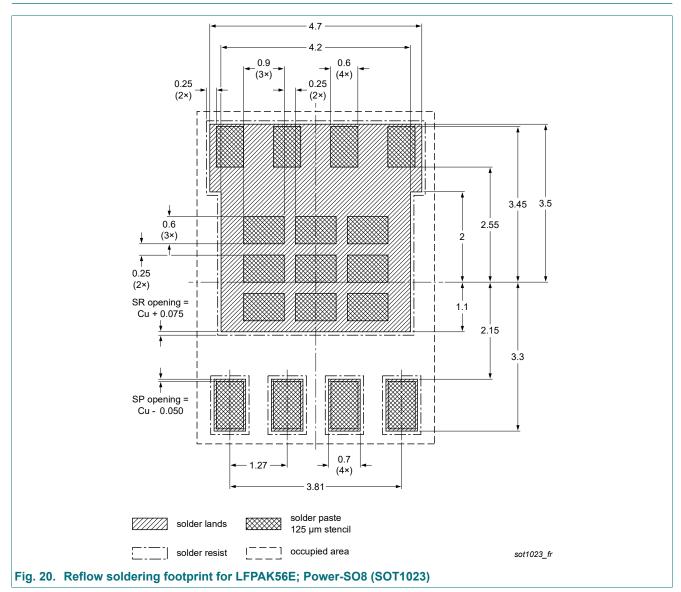




11. Package outline



12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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